MLX71122 300 to 930MHz

FSK/FM/ASK Receiver

Features

| Programmable PLL synthesizer |
|---|
| 8-channel preconfigured or fully programmable SPI mode |
| Double super-heterodyne receiver architecture with 2 nd mixer as image rejection mixer |
| Reception of FSK, FM and ASK modulated signals |
| Low shut-down and operating currents |
| AFC – automatic frequency correction |
| AGC – automatic gain control |
| On-chip IF filter |
| Fully integrated FSK/FM demodulator |
| RSSI for level indication and ASK detection |
| 2 nd order low-pass data filter |
| Positive and negative peak detectors |
| Data slicer (with averaging or peak-detector adaptive threshold) |
| 32-pin Quad Flat No-Lead Package (QFN) |

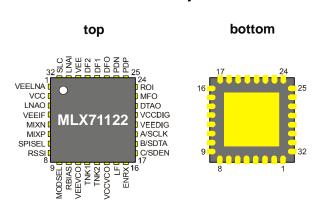
Ordering Information

| Part Number | Temperature Code | Package Code | Delivery Form |
|-------------|----------------------|------------------------|---------------------------|
| MLX71122 | R (-40 °C to 105 °C) | LQ (32 L QFN 5x5 Quad) | 73 pc/tube 5000 pc/T&R |

Application Examples

☐ General digital and analog RF receivers at 300 to 930MHz ☐ Tire pressure monitoring systems (TPMS) ☐ Remote keyless entry (RKE) □ Low power telemetry systems Alarm and security systems ☐ Active RFID tags ☐ Remote controls □ Garage door openers Home and building automation

Pin Description



General Description

The MLX71122 is a multi-channel RF receiver IC based on a double-conversion super-heterodyne architecture. It is designed to receive FSK and ASK modulated RF signals either in 8 predefined frequency channels or frequency programmable via a 3-wire serial programming interface (SPI).

The IC is designed for a variety of applications, for example in the European bands at 433MHz and 868MHz or for the use in North America or Asia, e.g. at 315MHz, 447MHz or 915MHz.



300 to 930MHz FSK/FM/ASK Receiver

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300 to 930MHz FSK/FM/ASK Receiver

1 Theory of Operation

1.1 General

The MLX71122 receiver architecture is based on a double-conversion super-heterodyne approach. The two LO signals are derived from an on-chip integer-N PLL frequency synthesizer. The PLL reference frequency is derived from a crystal (XTAL). The PLL synthesizer consists of an integrated voltage-controlled oscillator with external inductor, a programmable feedback divider chain, a programmable reference divider, a phase-frequency detector with a charge pump and an external loop filter.

In the receiver's down-conversion chain, two mixers MIX1 and MIX2 are driven by the internal local oscillator signals LO1 and LO2, respectively. The second mixer MIX2 is an image-reject mixer. As the first intermediate frequency (IF1) is very high (typically above 100 MHz), a reasonably high degree of image rejection is provided even without using an RF front-end filter. At applications asking for very high image rejections, cost-efficient RF front-end filtering can be realized by using a SAW filter in front of the LNA.

The receiver signal chain is set up by a low noise amplifier (LNA), two down-conversion mixers (MIX1 and MIX2), an on-chip IF filter (IFF) as well as an IF amplifier (IFA). By choosing the required modulation via an FSK/ASK switch (at pin MODSEL), either the on-chip FSK demodulator (FSK DEMOD) or the RSSI-based ASK detector is selected. A second order data filter (OA1) and a data slicer (OA2) follow the demodulator. The data slicer threshold can be generated from the mean-value of the data stream or by means of the positive and negative peak detectors (PKDET+/-).

In general the MLX71122 can be set to shut-down mode, where all receiver functions are completely turned off, and to several other operating modes. There are two global operating modes that are selectable via the logic level at pin SPISEL:

- 8-channel preconfigured mode (ABC mode)
- fully programmable mode (SPI mode).

In ABC mode the number of frequency channels is limited to eight but no microcontroller programming is required. In this case the three lines of the serial programming interface (SPI) are used to select one of the eight predefined frequency channels via simple 3-bit parallel programming. Pins ENRX and MODSEL are used to enable/disable the receiver and to select FSK or ASK demodulation, respectively.

SPI mode is recommended for full programming flexibility. In this case the three lines of the SPI are configured as a standard 3-wire bus (SDEN, SDTA and SCLK). This allows changing many parameters of the

receiver, for example more operating modes, channels, frequency resolutions, gains, demodulation types, data slicer settings and more. The pin MODSEL has no effect in this mode.

1.2 Technical Data Overview

| Input frequency ranges: 300 to 930MHz Power supply range: 3.0 to 5.5V | Minimum frequency resolution: 10kHz Total image rejection: > 65dB (with external |
|--|---|
| Temperature range: -40 to +105°C | RF front-end filter) |
| Shutdown current: 50nA | FSK/FM deviation range: ±10 to ±50kHz |
| Operating current: 12.5mA (typ.) | Spurious emission: < -70dBm |
| FSK input sensitivity: -107dBm (typ.) | Linear RSSI range: > 50dB |
| ASK input sensitivity: -112dBm (typ.) | FSK input frequency acceptance range: |
| Internal IF2: 2MHz with 230kHz 3dB bandwidth | 180kHz (3dB sensitivity loss) |
| Maximum data rate: 100kbps NRZ code, | Crystal reference frequency: 10MHz |
| 50kbps bi-phase code | |



1.3 Block Diagram

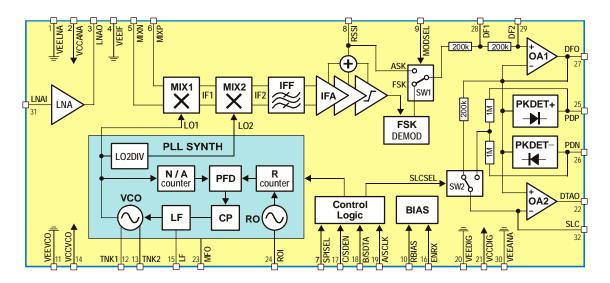


Fig. 1: MLX71122 block diagram

The MLX71122 receiver IC consists of the following building blocks:

- PLL synthesizer (PLL SYNTH) to generate the first and second local oscillator signals LO1 and LO2, parts of the PLL SYNTH are the voltage-controlled oscillator (VCO), the feedback dividers N/A and R, the phase-frequency detector (PFD), the charge pump (CP) and the crystal-based reference oscillator (RO)
- Low-noise amplifier (LNA) for high-sensitivity RF signal reception
- First mixer (MIX1) for down-conversion of the RF signal to the first IF (intermediate frequency)
- Second mixer (MIX2) with image rejection for down-conversion from the first to the second IF
- IF Filter (IFF) with a 2MHz center frequency and a 230kHz 3dB bandwidth
- IF amplifier (IFA) to provide a large amount of voltage gain and an RSSI signal output
- FSK demodulator (FSK DEMOD)
- Operational amplifiers OA1 and OA2 for low-pass filtering and data slicing, respectively
- Positive (PKDET+) and negative (PKDET-) peak detectors
- Switches SW1 to select between FSK and ASK as well as SW2 to chose between averaging or peak detector data slicer
- Control logic with 3-wire bus serial programming interface (SPI)
- · Biasing circuit with modes control

MLX71122 300 to 930MHz FSK/FM/ASK Receiver

1.4 Enable/Disable in ABC Mode

| ENRX | Description |
|------|---------------|
| 0 | Shutdown mode |
| 1 | Receive mode |

Pin ENRX is pulled down internally. Device is in shutdown by default, after power supply on. If ENRX = 0 and SPISEL = 1 then operating modes according to OPMODE bit (refer to control word R0). If ENRX = 1 then OPMODE bit has no effect (hardwired receive mode).

1.5 Demodulation Selection in ABC Mode

| MODSEL | Description |
|--------|------------------|
| 0 | FSK demodulation |
| 1 | ASK demodulation |

Pin MODSEL has no effect in SPI mode (SPISEL = 1). We recommend connecting it to ground to avoid a floating CMOS gate.

1.6 Programming Modes

| SPISEL Description | | | |
|--------------------|---------------------------------------|--|--|
| 0 | ABC mode (8 channels preconfigured) | | |
| 1 | SPI mode (programming via 3-wire bus) | | |

1.7 Preconfigured Frequencies in ABC Mode

| Α | В | С | Receive Frequency |
|---|---|---|-------------------|
| 0 | 0 | 0 | FSK1: 369.5 MHz |
| 0 | 1 | 0 | FSK5: 388.3 MHz |
| 1 | 0 | 0 | FSK2: 371.1 MHz |
| 1 | 1 | 0 | FSK4: 376.9 MHz |
| 0 | 0 | 1 | FSK3: 375.3 MHz |
| 0 | 1 | 1 | FSK7: 394.3 MHz |
| 1 | 0 | 1 | FSK6: 391.5 MHz |
| 1 | 1 | 1 | FSK8: 395.9 MHz |

As all pins, pins A, B, and C are equipped with ESD protection diodes that are tied to VCC and to VEE. Therefore these pins should not be directly connected to positive supply (a logic "1") before the supply voltage is applied to the IC. Otherwise the IC will be supplied through these control lines and it may enter into an unpredictable mode. In case the user wants to apply a positive supply voltage to these pins before the supply voltage is applied to the IC, a protection resistor should be inserted in each control line.



2 Pin Definitions and Descriptions

| Pin No. | Name | I/O Type | Functional Schematic | Description |
|---------|--------|------------------|--|--|
| 1 | VEELNA | ground | u vcc u | ground of LNA core |
| 31 | LNAI | analog input | LNAI VEELNA 1 31 VEELNA 1 VEELNA 1 VEELNA 1 VEELNA | LNA input, approx. 27Ω single-ended |
| 3 | LNAO | analog output | LNAO bias VEE | LNA open-collector output, to be connected to external LC tank that resonates at RF |
| 2 | VCCANA | supply | | positive supply of LNA, MIX1 MIX2, IFF, IFA, FSK DEMOD, OA1, OA2, PKDET+, PKDET- and BIAS |
| 4 | VEEIF | ground | | negative supply of LNA, MIX1 MIX2, IFF, IFA, and FSK DEMOD |
| 5 | MIXN | analog input | VCC bias VCC WCC | mixer 1 negative input |
| 6 | MIXP | analog input | 5 390μA VEE VEE | mixer 1 positive input |
| 7 | SPISEL | CMOS input | SPISEL 120 VEE | SPI select input |
| 8 | RSSI | analog output | RSSI 120 ASK VEE SWI | RSSI output, approx. 25kΩ |
| 9 | MODSEL | CMOS input | MODSEL 120 9 | demodulation select input (FSK or ASK demodulation) |



| Pin No. | Name | I/O Type | Functional Schematic | Description |
|---------|--------|---------------|--|--|
| 10 | RBIAS | analog I/O | RBIAS 50 VCC FIRE VCC | external resistor for voltage and current biasing, $30k\Omega$ by default, to provide stable parameters over temperature and supply variations |
| 11 | VEEVCO | ground | | ground of VCO |
| 12 | TNK1 | analog I/O | TNK1 VD VD TNK2 | VCO collector output, connection 1 to external LC tank |
| 13 | TNK2 | analog I/O | VEE VEE | VCO collector output, connection 2 to external LC tank |
| 15 | LF | analog I/O | VCC VCO VCC VCO VCC VCO VCC VCO VCC VCO VCO | charge pump output, connection to external loop filter |
| 14 | vccvco | supply | | positive supply of VCO |
| 16 | ENRX | CMOS input | ENRX 120 VEE | enable/disable control input (with internal pull-down) |
| 17 | C/SDEN | CMOS input | C/SDEN 120 VEE | frequency control line C or SPI control line SDEN |



| Pin No. | Name | I/O Type | Functional Schematic | Description |
|---------|--------|-----------------|----------------------|---|
| 18 | B/SDTA | CMOS input | B/SDTA 120 VEE | frequency control line B or SPI control line SDTA |
| 19 | A/SCLK | CMOS input | A/SCLK 120 VEE | frequency control line A or SPI control line SCLK |
| 20 | VEEDIG | ground | | ground of PLL SYNT (except of VCO), Control Logic, and OA2 out stage |
| 21 | VCCDIG | supply | | positive supply of PLL SYNT (except of VCO), Control Logic, RO and OA2 out stage |
| 22 | DTAO | CMOS output | DTAO VCC OA2 | data output, 2mA sink or source capability |
| 23 | MFO | DR. | MFO 150 ROI VEE | multifunctional output, reference oscillator output by default |
| 24 | ROI | analog input | ROI 30p 30p VEE | reference oscillator input for connecting an external crystal, Colpitts type oscillator with internal feedback capacitors |

| Pin No. | Name | I/O Type | Functional Schematic | Description |
|---------|--------|------------------|---|--|
| 25 | PDP | analog I/O | PDP 120 VCC | peak detector positive output for connecting an external capacitor |
| 26 | PDN | analog I/O | PDN Sw2 Sw2 | peak detector positive output for connecting an external capacitor |
| 27 | DFO | analog output | DFO SID VEE VEE | data filter output |
| 28 | DF1 | analog I/O | DF1 200K SWI ASK SWI ASK FSK | data filter connection 1 for connecting an external capacitor |
| 29 | DF2 | analog I/O | DF2 OA1 | data filter connection 2 for connecting an external capacitor |
| 30 | VEEANA | ground | | ground of RO, OA1, OA2, PKD+, PKD- and BIAS |
| 32 | SLC | analog I/O | SLC 120 VEE OA2 | slicer reference input for connecting an external capacitor |



3 Functional Description

3.1 Frequency Planning

Because of the double conversion architecture that employs two mixers and two IF signals, there are four different combinations for injecting the LO1 and LO2 signals:

LO1 high side and LO2 high side: receiving at f_{RF}(high-high)
 LO1 high side and LO2 low side: receiving at f_{RF}(high-low)
 LO1 low side and LO2 high side: receiving at f_{RF}(low-high)
 LO1 low side and LO2 low side: receiving at f_{RF}(low-low)

As a result, four different radio frequencies (RFs) could yield one and the same second IF (IF2). Fig. 2 shows this for the case of receiving at f_{RF} (high-high). In the example of Fig. 2, the image signals at f_{RF} (low-high) and f_{RF} (low-low) are suppressed by the bandpass characteristic provided by the RF front-end. The bandpass shape can be achieved either with a SAW filter (featuring just a couple of MHz bandwidth), or by the tank circuits at the LNA input and output (this typically yields 30 to 60MHz bandwidth). In any case, the high value of the first IF (IF1) helps to suppress the image signals at f_{RF} (low-high) and f_{RF} (low-low).

The two remaining signals at IF1 resulting from $f_{RF}(high-high)$ and $f_{RF}(high-low)$ are entering the second mixer MIX2. This mixer features image rejection with so-called single-sideband (SSB) selection. This means either the upper or lower sideband of IF1 can be selected. In the example of Fig. 2, LO2 high-side injection has been chosen to select the IF2 signal resulting from $f_{RF}(high-high)$.

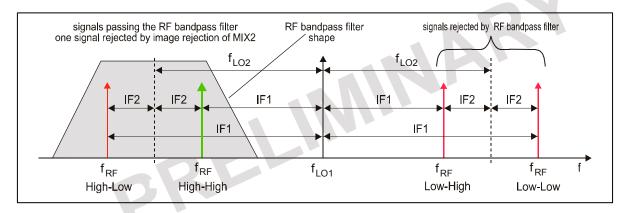


Fig. 2: The four receiving frequencies in a double conversion superhet receiver

It can be seen from the block diagram of Fig. 1 that there is a fixed relationship between the LO1 signal frequency f_{LO1} and the LO2 signal frequency f_{LO2} .

$$LO2DIV = N_{LO2} = \frac{f_{LO1}}{f_{LO2}}$$
 (1)

The LO1 signal frequency f_{LO1} is directly synthesized from the crystal reference oscillator frequency f_{RO} by means of an integer-N PLL synthesizer. The PLL consists of a dual-modulus prescaler (P/P+1), a program counter N and a swallow counter A.

$$f_{\text{LO1}} = \frac{f_{\text{RO}}}{R}(N \cdot P + A) = f_{\text{PFD}}(N \cdot P + A) = f_{\text{PFD}} \cdot N_{\text{tot}}$$
 (2)

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Due to the double superhet receiver architecture, the channel frequency step size f_{CH} is not equal to the phase-frequency detector (PFD) frequency f_{PFD} . For high-side injection, the channel step size f_{CH} is given by:

$$f_{CH} = \frac{f_{RO}}{R} \frac{N_{LO2} - 1}{N_{LO2}} = f_{PFD} \frac{N_{LO2} - 1}{N_{LO2}}$$
(3)

While the following equation is valid for low-side injection:

$$f_{CH} = \frac{f_{RO}}{R} \frac{N_{LO2} + 1}{N_{LO2}} = f_{PFD} \frac{N_{LO2} + 1}{N_{LO2}}$$
(4)

3.2 Calculation of Counter Settings

Frequency planning and the selection of the MLX71122's PLL counter settings are straightforward and can be laid out on the following procedure.

Usually the receive frequency f_{RF} and the channel step size f_{CH} are given by system requirements. The N and A counter settings can be derived from N_{tot} or f_{LO1} and f_{PFD} by using the following equations.

$$N = floor(\frac{N_{tot}}{P}) = floor(\frac{N_{tot}}{32}); A = N_{tot} - N \cdot P = N_{tot} - N \cdot 32$$
 (5)

3.2.1 Calculation of LO1 and IF1 frequency for Low Frequency Bands

High-high injection must be used for the low frequency bands. First of all choose a PFD frequency f_{PFD} according to below table. The R counter values are valid for a 10MHz crystal reference frequency f_{RO} . The PFD frequency is given by $f_{PFD} = f_{RO} / R$.

| Injection Type | f _{CH} [kHz] | f _{PFD} [kHz] | R |
|----------------|-----------------------|------------------------|-----|
| h-h | 10 | 13.3 | 750 |
| h-h | 12.5 | 16.7 | 600 |
| h-h | 20 | 26.7 | 375 |
| h-h | 25 | 33.3 | 300 |
| h-h | 50 | 66.7 | 150 |
| h-h | 100 | 133.3 | 75 |
| h-h | 250 | 333.3 | 30 |

The second step is to calculate the missing parameters f_{LO1} , f_{IF1} , N_{tot} , N and A. While the second IF (f_{IF2}), the N_{LO2} divider ratio and the prescaler divider ratio P are bound to f_{IF2} = 2MHz, N_{LO2} = 4 (or 8) and P =32.

$$f_{LO1} = \frac{N_{LO2}}{N_{LO2} - 1} (f_{RF} - f_{IF2})$$
 $f_{LO1} = \frac{4}{3} (f_{RF} - 2MHz)$ (6)

$$f_{IF1} = \frac{f_{RF} - N_{LO2}f_{IF2}}{N_{LO2} - 1} \qquad f_{IF1} = \frac{f_{RF} - 8MHz}{3}$$
 (7)

Finally N and A can be calculated with formula (5).



3.2.2 Calculation of LO1 and IF1 frequency for High Frequency Bands

Typical ISM band operating frequencies like 868.3 and 915MHz can be covered without changing the crystal nor the VCO inductor.

Low-low injection should be used for the high frequency bands. First of all choose a PFD frequency f_{PFD} according to below table. The R counter values are valid for a 10MHz crystal reference. The PFD frequency is given by $f_{PED} = f_{RO} / R$.

| Injection Type | f _{CH} [kHz] | f _{PFD} [kHz] | R |
|----------------|-----------------------|------------------------|-----|
| I-I | 20 | 16 | 625 |
| I-I | 25 | 20 | 500 |
| I-I | 50 | 40 | 250 |
| I-I | 100 | 80 | 125 |
| I-I | 250 | 200 | 50 |
| I-I | 500 | 400 | 25 |

The second step is to calculate the missing parameters f_{LO1} , f_{IF1} , N_{tot} , N and A. While the second IF (f_{IF2}) , the N_{LO2} divider ratio and the prescaler divider ratio P are bound to $f_{IF2} = 2MHz$, $N_{LO2} = 4$ (or 8) and P = 32.

$$f_{LO1} = \frac{N_{LO2}}{N_{LO2} + 1} (f_{RF} - f_{IF2}) \qquad f_{LO1} = \frac{4}{5} (f_{RF} - 2MHz)$$
 (8)

$$f_{LO1} = \frac{N_{LO2}}{N_{LO2} + 1} (f_{RF} - f_{IF2}) \qquad f_{LO1} = \frac{4}{5} (f_{RF} - 2MHz)$$

$$f_{IF1} = \frac{f_{RF} + N_{LO2} f_{IF2}}{N_{LO2} + 1} \qquad f_{IF1} = \frac{f_{RF} + 8MHz}{5}$$
(9)

Finally N and A can be calculated with formula (5).

3.2.3 Counter Setting Examples for SPI Mode

To provide some examples, the following table shows some counter settings for the reception of the wellknown ISM and SRD frequency bands. The channel spacing is assumed to be f_{CH} = 100kHz. In below table all frequency units are in MHz.

| lnj | f _{RF} | f _{IF1} | f _{LO1} | N _{tot} | N | Р | Α | f _{PFD} | R | f _{REF} | f _{LO2} | f _{IF2} |
|-----|-----------------|------------------|------------------|------------------|-----|----|----|------------------|-----|------------------|------------------|------------------|
| h-h | 300 | 97.3 | 397.3 | 2980 | 93 | 32 | 4 | 0.133 | 75 | 10 | 99.3 | 2 |
| h-h | 315 | 102.3 | 417.3 | 3130 | 97 | 32 | 26 | 0.133 | 75 | 10 | 104.3 | 2 |
| h-h | 434 | 142 | 576 | 4320 | 135 | 32 | 0 | 0.133 | 75 | 10 | 144 | 2 |
| h-h | 470 | 154 | 624 | 4680 | 146 | 32 | 8 | 0.133 | 75 | 10 | 156 | 2 |
| I-I | 850 | 171.6 | 678.4 | 8480 | 256 | 32 | 0 | 0.08 | 125 | 10 | 169.6 | 2 |
| I-I | 868 | 175.2 | 692.8 | 8660 | 270 | 32 | 20 | 0.08 | 125 | 10 | 173.2 | 2 |
| I-I | 915 | 184.6 | 730.4 | 9130 | 285 | 32 | 10 | 0.08 | 125 | 10 | 182.6 | 2 |
| I-I | 930 | 187.6 | 742.4 | 9280 | 290 | 32 | 0 | 0.08 | 125 | 10 | 185.6 | 2 |



3.2.4 Counter Settings in ABC Mode – 8 Preconfigured Channels

In ABC mode (SPISEL=0), the counter settings are hard-wired. In below table all frequency units are in MHz.

| FSK | f _{RF} | f _{IF1} | f _{LO1} | N _{tot} | N | Р | Α | f _{PFD} | R | f _{REF} | f _{LO2} | f _{IF2} |
|-----|-----------------|------------------|------------------|------------------|-----|----|----|------------------|----|------------------|------------------|------------------|
| 1 | 369.5 | 120.5 | 490.0 | 3675 | 114 | 32 | 27 | 0.133 | 75 | 10 | 122.5 | 2 |
| 2 | 371.1 | 121.0 | 492.0 | 3691 | 115 | 32 | 11 | 0.133 | 75 | 10 | 123.0 | 2 |
| 3 | 375.3 | 122.4 | 497.7 | 3733 | 116 | 32 | 21 | 0.133 | 75 | 10 | 124.4 | 2 |
| 4 | 376.9 | 123.0 | 499.9 | 3749 | 117 | 32 | 5 | 0.133 | 75 | 10 | 125.0 | 2 |
| 5 | 388.3 | 126.8 | 515.1 | 3863 | 120 | 32 | 23 | 0.133 | 75 | 10 | 128.8 | 2 |
| 6 | 391.5 | 127.8 | 519.3 | 3895 | 121 | 32 | 23 | 0.133 | 75 | 10 | 129.8 | 2 |
| 7 | 394.3 | 128.8 | 523.1 | 3923 | 122 | 32 | 19 | 0.133 | 75 | 10 | 130.8 | 2 |
| 8 | 395.9 | 129.3 | 525.2 | 3939 | 123 | 32 | 3 | 0.133 | 75 | 10 | 131.3 | 2 |

3.3 PLL Frequency Synthesizer

The MLX71122 contains an integer-N PLL frequency synthesizer. The reference frequency f_R is derived from a stable crystal reference oscillator.

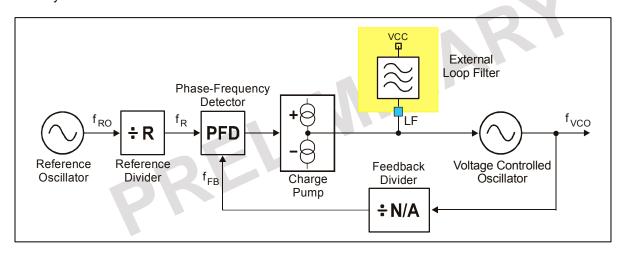


Fig. 3: Integer-N PLL Frequency Synthesizer Topology

The locked state of the PLL is defined by the following relations:

$$\frac{f_{RO}}{R} = f_{R} = f_{PFD} = f_{FB} = \frac{f_{VCO}}{N_{tot}} = \frac{f_{VCO}}{N \cdot P + A}.$$
 (10)

In this formula the total PLL feedback divider ratio is called N_{tot} . The synthesized output frequency f_{VCO} can be changed by reprogramming the reference divider or the feedback divider according to

$$f_{\text{VCO}} = N_{\text{tot}} \frac{f_{\text{RO}}}{R} = (N \cdot P + A) \frac{f_{\text{RO}}}{R}. \tag{11}$$

The R counter is used to set the channel spacing. Different channels can be selected by changing the total feedback divider ratio.

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| | List of Mathematical Acronyms |
|---------------------------|--|
| A | divider ratio of the swallow counter (part of feedback divider) |
| $f_{	ext{FB}}$ | frequency at the feedback divider output |
| floor (x) | The floor function gives the largest integer less than or equal to x. For example, floor(5.4) gives 5, floor(-6.3) gives -7. |
| $f_{	ext{PFD}}$ | PFD frequency in locked state |
| $\frac{f_{RO}}{R} = f_R$ | reference frequency of the PLL |
| f_{RO} | frequency of the crystal reference oscillator |
| f_{VCO} | frequency of the VCO (equals the LO1 signal of the first mixer) |
| $N_{tot} = N \cdot P + A$ | total divider ratio of the PLL feedback path |
| N | divider ratio of the program counter (part of feedback divider) |
| N _{LO2} | LO2DIV divider ratio, to derive the LO2 signal from LO1 (N ₁ = 4 or 8) |
| P | divider ratio of the prescaler (part of feedback divider) |
| R | divider ratio of the reference divider R |

3.3.1 Pulse Swallow Counter

The programmable feedback divider of the PLL is based on a pulse-swallow topology. Fig. 4 depicts its implementation, consisting of a dual-modulus prescaler, an RS latch and two programmable counters.

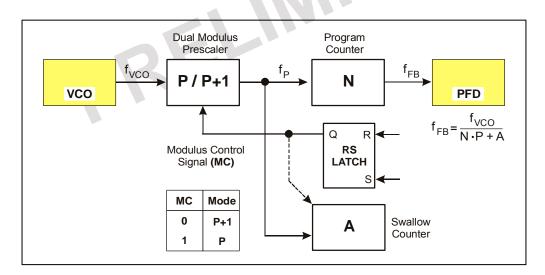


Fig. 4 Pulse Swallow Counter Topology

During one cycle of f_{FB} the prescaler begins the operation by dividing by P+1 until the swallow counter A is full. The RS latch is then set and changes the prescaler modulus to P (via the modulus control signal MC) and disables the swallow counter. The division process continues until the program counter N is full and the RS latch is reset.

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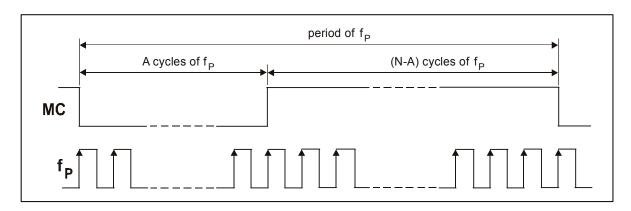


Fig. 5 Pulse Swallow Divider Timing

Therefore the overall feedback divide ratio is:

$$(P+1)\cdot A + P\cdot (N-A) = N\cdot P + A. \tag{12}$$

Further restrictions can be derived from above equation: A < P and A < N.

Simple math shows that for uniform frequency steps the following condition is necessary:

$$N \cdot P + A \ge P \cdot P . \tag{13}$$

3.3.2 PLL Counter Ranges

In order to cover the frequency range of about 300 to 930MHz the following counter values are implemented in the receiver:

| | PLL Counter Ranges | | | | | | | | | | | |
|---|--------------------|---|---|--|--|--|--|--|--|--|--|--|
| Α | N | R | Р | | | | | | | | | |
| 0 to 31 (5bit) 3 to 2047 (11bit) 3 to 2047 (11bit) 32 | | | | | | | | | | | | |

Therefore the minimum and maximum divider ratios of the PLL feedback divider are given by:

$$N_{totmin} = 32 \cdot 32 = 1024$$
 $N_{totmax} = 2047 \cdot 32 + 31 = 65535$

3.3.3 Reference Oscillator (RO)

The reference oscillator is based on a Colpitts topology with two integrated functional capacitors as shown in figure 6. The circuitry is optimized for a load capacitance range of 10pF to 15pF. The equivalent input capacitance CRO offered by the oscillator input pin ROI is about 15pF. To ensure a fast and reliable start-up and a very stable frequency over the specified supply voltage and temperature range, the oscillator bias circuitry provides an amplitude regulation. The amplitude at pin ROI is monitored in order to regulate the current of the oscillator core I_{RO} . In SPI-mode it is possible to adjust the typical core current with register ROCUR. There are four values available (see 4.1.7). In ABC-mode I_{RO} = 355 μ A is used as default current.

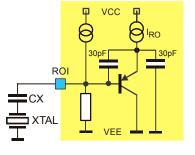


Fig.6: RO schematic

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3.3.4 Phase-Frequency Detector (PFD)

The phase-frequency detector (in conjunction with the charge pump) generates a voltage step at the loop filter pin LF. This voltage step is proportional to the phase difference between the digital input signals f_R and f_{FB} . The implementation of the phase detector is phase-frequency type. This circuitry is very useful because it decreases the acquisition time significantly even if both frequencies differ very much. The phase-frequency detector creates Up and Down signals that control the charge pump and that are also used for the lock detection circuit. The first rising edge of one of the input signals, after a reset of Up and Down, sets either the Up or the Down signal from LOW to HIGH. The following rising edge of the other signal resets Up and Down. If the register setting PFDPOL (see 4.1.2) is HIGH, the PFD polarity is positive. This means a rising edge of the signal f_R sets Up from LOW to HIGH and a rising edge of the signal f_{FB} sets Down from LOW to HIGH. If PFDPOL is LOW, the PFD polarity is negative and the assignment of Up and Down to the signals f_R and f_{FB} is swapped.

In the MLX71122 receiver the VCO frequency increases if the loop filter output voltage increases and vice versa. The PFD polarity needs to be positive to achieve the correct feedback in the PLL loop. If an external varactor diode is added to the VCO tank, the tuning characteristic may change from positive to negative depending on the particular varactor diode circuitry. Therefore the PFDPOL bit can be used to define the phase-frequency detector polarity.

3.3.5 Charge Pump (CP)

The Charge Pump is controlled by the Up and Down signals of the Phase-Frequency Detector. If the Up signal is HIGH, then the charge pump current I_{CP} is sourced from the positive supply rail to the loop filter pin LF (pin 15). If the Down signal is HIGH, then the current I_{CP} is drained from pin LF to ground. The gain of the phase detector in conjunction with the charge pump can be expressed as:

$$K_{PD} = \frac{I_{CP}}{2\pi} , \qquad (14)$$

whereat I_{CP} is the charge pump current which is set via register CPCUR (see 4.1.2). Default of I_{CP} is $100\mu A$. The static Up and Down selections of I_{CP} can be used for test purposes.

3.3.6 Loop Filter (LF)

Since the loop filter has a strong impact on the function of the PLL, it must be chosen carefully. The suggested filter topology is shown in Fig. 7.

The loop filter of the PLL is set up by an external resistor and two external capacitors. It constitutes a 2nd order passive filter. This approach allows the user to easily adapt the loop filter bandwidth to different requirements. As a rule of thumb the loop filter bandwidth of an integer-N PLL should be set 10 times smaller than the PFD frequency. This is to achieve a stable PLL with a flat VCO noise floor.

The loop filter bandwidth depends on the external resistor and capacitors as well as on the VCO gain, the charge pump current and the so-called phase margin. A phase margin of 45° is commonly used for highest PLL stability. It is recommended to follow the component lists of section 6 for choosing appropriate values of the loop filter resistor and capacitors.

A good source for a detailed PLL analysis is: "Gardner, F.M., Phase-Locked Loop Techniques, John Wiley & Sons, 1980."

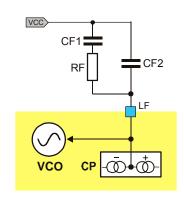


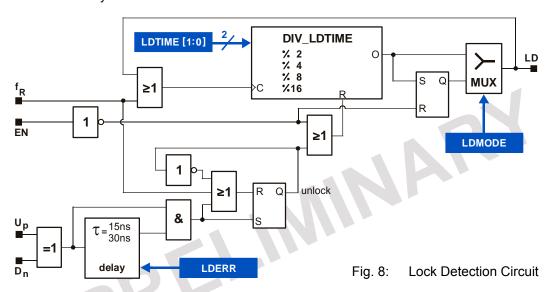
Fig. 7: 2nd order Loop filter

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3.3.7 Lock Detector (LD)

In SPI mode a lock-detect signal LD is available at pin 23 if MFO is set to 1000 (binary) in control word R3 (see 4.1.4). The pin output is HIGH when the PLL is locked in. Alternatively the lock-detect signal is visible in bit 10 of R7 (see 4.1.8) if bit SHOWLD in R1 (see 4.1.2) is HIGH. The lock detection circuitry uses the Up and Down signals from the phase-frequency detector to check them for phase coherency. Figure 8 shows an overview of the lock signal generation. The locked state and the unlock condition will be controlled by the register settings of LDTIME and LDERR. During the start-up phase of the PLL, Up and Down signals are quite unbalanced. Therefore the Lock Detector circuit waits the time span that is programmed in divider DIV_LDTIME before a first lock can occur. The time span is dependent on the period of the reference signal f_R . By default it is $16/f_R$ (see 4.1.2). When the PLL approaches steady state, the signals Up and Down begin to overlap. The time span within which the signals are not overlapping is assessed by using a programmable delay gate. If it is shorter than programmed in LDERR (see 4.1.2) then the LD output is set to HIGH. By default the error time should be shorter than 15ns. A second option is shorter than 30ns.

After LD is set to HIGH the divider is disabled and the lock state remains unchanged until the unlock signal resets the divider. If LDMODE in register R1 (see 4.1.2) is HIGH then the LD output can not be reset. It remains HIGH until the synthesizer is turned off.



3.3.8 Voltage Controlled Oscillator (VCO)

The receiver includes an LC-based voltage controlled oscillator with an external inductor connected between pins TNK1 and TNK2. Two internal varactor diodes in series combination are forming the tuneable part of the oscillator tank. The oscillation frequency is adjusted by the DC voltage at pin LF. The tuning sensitivity of the VCO is approximately 83MHz/V for 433MHz operation and 105MHz/V at 868MHz, respectively. Since the cathodes of the varactors is tied to VCC, a higher voltage at pin LF or an Up-signal of the PFD forces the capacitance to decrease and the VCO frequency to increase. With positive phase detector polarity (PFDPOL = HIGH) the edges of the signal $f_{\rm FB}$ will catch up to the reference signal $f_{\rm R}$ (see Fig. 3).

The VCO current VCOCUR can be adjusted via the SPI in order to ensure stable oscillations over the whole frequency range. Also the bias current of the output buffer can be increased with VCOBUF to enhance its driving capability at the high frequency bands above 800MHz (see section 4.1.2). If the supply voltage is lower than 5V it is possible to adjust the tuning range of the VCO with VCORANGE (see 4.1.2). The minimum supply voltage is 3V.

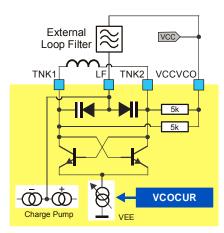


Fig.9: VCO schematic



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3.4 Receiver Front End

The radio frequency (RF) front-end of the receiver is a double-superheterodyne configuration that converts the input RF signal via a first intermediate frequency (IF1) signal to a second intermediate frequency (IF2) signal. While the range of IF1 can vary between 100 and 200MHz, IF2 is fixed to 2MHz. Both signals are completely processed internally. According to the block diagram (see Fig. 1), the front-end consists of an LNA, a first mixer (MIX1), a second mixer (MIX2), an internal IF filter (IFF) and an IF limiting amplifier (IFA) with received signal strength indicator (RSSI). The local oscillator signal for mixer 1 (LO1) is directly generated in the PLL frequency synthesizer. The LO2 signal for mixer 2 is derived from the LO1 signal via a divider (see 4.1.4).

There is no inherent suppression of the first mixer's image frequency. It depends on the particular application and the system's environmental conditions whether an RF front-end filter should be added or not. If image rejection and/or good blocking immunity are relevant system parameters, a band-pass filter must be placed either in front or after the LNA. This filter can be a SAW (surface acoustic wave) or LC-based filter (e.g. helical type). Because mixer 2 is an image rejection mixer, the image frequencies of the second mixing process are suppressed (see Fig. 2). The advantage of a two stage mixing receiver is the higher gain that can be achieved in the front end.

3.4.1 Low Noise Amplifier (LNA) and Mixer 1 (MIX1)

The LNA is based on a cascode topology for low-noise, high gain and good reverse isolation. The open collector output has to be connected to an external resonance circuit tuned to the receive frequency. The gain of the LNA can be changed to achieve a high dynamic range. There are four gain settings selectable by the control bits LNAGAIN (see 4.1.1). Default setting is the highest gain. The gain settings are automatically set if the automatic gain control (AGC) feature is activated (see 4.1.4).

The first mixer is a double-balanced mixer which converts the receive frequency to IF1. The default LO injection type for RF frequencies below 600MHz should be high side ($f_{LO1} = f_{RX} + f_{IF1}$). Low side injection ($f_{LO1} = f_{RX} - f_{IF1}$) is recommended for the higher frequency bands. Since the data polarity of an FSK modulated signal will be inverted by changing the injection side it is possible to change the data polarity at the data output (DTAO) via bit DTAPOL (see 4.1.1). Two gain settings of mixer 1 can be selected through MIX1GAIN (see 4.1.1): 14dB as a default value or 0dB optionally.

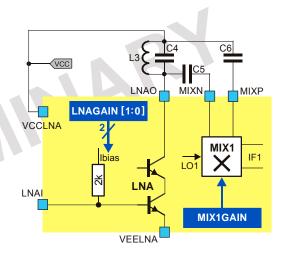


Fig. 10: LNA and Mixer 1

3.4.2 Mixer 2 (MIX2)

The second mixer is a double-balanced image rejection mixer in Hartley architecture using a complex poly-phase filter that converts the IF1 to the IF2 signal. The default LO injection type is high side ($f_{LO2} = f_{IF1} + f_{IF2}$), but also low side injection is possible ($f_{LO2} = f_{IF1} - f_{IF2}$), by setting SSBSEL to LOW (see 4.1.1). As for mixer 1, the injection side determines the polarity of the output signal. Two gain settings of mixer 2 can be selected by MIX2GAIN (see 4.1.1), a setting at 9dB (default) and one at -2dB.

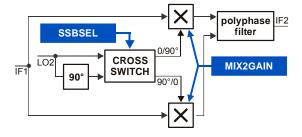


Fig. 11: Mixer 2 (Image Rejection Mixer)

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3.4.3 IF Filter (IFF)

The MLX71122 comprises an internal IF filter with a -3dB bandwidth of 230kHz and a -40dB attenuation bandwidth of 1.6MHz. The filter contains three capacitively coupled bi-quad stages that represent resonant tanks at a filter center frequency of 2MHz. Each bi-quad stage uses transconductance cells that can be tuned by changing their bias current. An auto-tuning mechanism is implemented that permanently adjusts the bias current to eliminate process, temperature and supply voltage variations. A matched master bi-quad is used in a current controlled oscillator (CCO) at 3MHz embedded in a PLL structure. The PFD-frequency of this PLL is derived from the RO signal using divider RIFF (see 4.1.6). The actual internal control word IFFVAL of the filter can be read out from register 7 (see. 4.1.8). At power on and after deactivation of the IF filter with IFFTUNE (see 4.1.7), the preset value that is stored in IFFPRES in register 6 (see 4.1.7) will be loaded into the internal control word. If the filter auto tuning is halted via IFFHLT (see 4.1.7) then the actual word remains in the internal control word but is not updated. The internal control word determines the current consumption of the filter and therefore of the whole receiver. Higher values lead to higher current consumptions. The deviation from the nominal current consumption can be about ±0.75mA. Four gain settings of the IF filter are selectable via IFFGAIN in register R0 (see 4.1.1). The default value is +6dB, other options are -14dB, -6dB and 0dB.

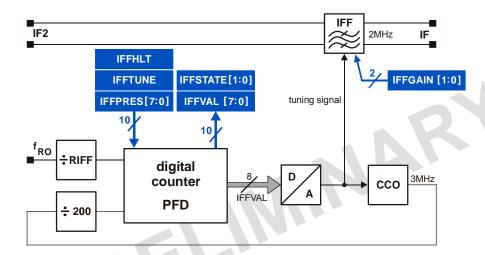


Fig. 12: IF filter auto-tuning circuit



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3.4.4 IF Amplifier (IFA)

After passing the IF filter the receiving signal is amplitude limited by means of a high gain limiting amplifier. Its small signal gain is about 68dB. A received signal strength indicator (RSSI) voltage is generated in the IF amplifier. It is available at pin RSSI. The voltage at this pin is proportional to the input level of the receiver (in dB scales). By using this RSSI output signal the incoming signal strength of different transmitters can be determined. The same RSSI signal is used for receiving ASK modulated signals if MODSEL (see 4.1.6) is HIGH.

The IFA generates two digital signals RSSIL and RSSIH that indicate the level range of the RSSI voltage. If the level is in the lower quarter of the RSSI voltage range then both signals are LOW. If it is in the upper quarter of the RSSI range then both signals are HIGH. In between, the RSSIL signal is HIGH and RSSIH is LOW. Both values can be read out from register R7 of the IC (see 4.1.8). These two signals are also used for the AGC feature.

3.4.5 Automatic Gain Control (AGC)

The Automatic Gain Control (AGC) can be activated in SPI mode with AGCEN (see 4.1.4). By default, it is turned off. It uses the RSSIH and RSSIL signals of the IF amplifier to determine whether the gain has to be increased or decreased. The gain will be decreased beginning with the gain of the last stage. The gain increase works vice versa. The AGC circuit controls the gain of the LNA, and of mixer 1 and mixer 2. To avoid rapid gain switching, caused by short signal strength fluctuations or during ASK reception, the gain control operates with a time delay that can be programmed via AGCDEL (see 4.1.4). The time delay also depends on the PFD frequency of the IF filter auto-tuning circuit. There is no delay by default. AGCMODE (see 4.1.5), a second setting, determines whether the delay is applied for gain increase and decrease or only for gain increase. By default, a delay for increase and decrease is used.

3.4.6 FSK Demodulator

FSK reception is turned on if bit MODSEL in register R5 is set to LOW (default). The demodulator is completely internally implemented, so no external, expensive discriminator device is needed. The used FSK demodulator is based on time delay elements and a mixer. The delay path provides a phase shift of 90 degrees to the original IF signal. The average of the phase shift is controlled, so that the input frequency acceptance range is wider than the IF filter bandwidth of 230kHz. The gain of the demodulator can be changed with bit DEMGAIN (see 4.1.1). It can be at low gain with about 4mV/kHz (default) or at high gain with about 15mV/kHz. High gain should only be used for small FSK/FM deviations of up to ±15kHz, because the demodulator gets nonlinear at larger FM/FSK deviations.

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3.5 Data Path

The data path contains all circuitry that is used to process the baseband signal. The MLX71122 comprises a second order Sallen-Key lowpass filter, two peak detectors and an output comparator as digital signal output.

3.5.1 Data Filter (DF)

The receive part of the MLX71122 contains a 2nd order Sallen-Key low-pass filter that can be configured by connecting two external capacitors C8 and C9 to the IC (see sec. 6). This data filter removes high frequency components and noise from the demodulated signal that may otherwise lower the signal to noise ratio at the comparator input. The filter bandwidth has to be adjusted to the maximum data rate. A good choice for the -3dB bandwidth is 75% of the data rate for NRZ codes and 150% for bi-phase or Manchester codes.

A Butterworth characteristic is commonly used in the data filter. To compensate parasitic effects of the board and IC, we recommend calculating the filter characteristic with a slight amplitude peaking, e.g. a 0.035dB Tschebyschew filter characteristic.

Since the internal resistors of the filter are both $200k\Omega$ and the overall gain is set to unity we obtain the following table for the capacitor values:

| Coding | C8 | С9 |
|---------------|--------|----------------------------|
| NRZ Code | 2.2·C9 | 560 pF data rate / kbps |
| Bi-Phase Code | 2.2·C9 | 280 pF data rate / kbps |

Example: base band signal 4kbps, NRZ coding

$$C9 = \frac{560 \text{pF}}{4 \text{[kbps]}} = 140 \text{pF} \qquad \text{in E-series} \implies C9 = 150 \text{pF}$$

$$C8 = 2.2 \cdot 150 \text{pF} = 330 \text{pF}$$
 in E-series $\Rightarrow C8 = 330 \text{pF}$

3.5.2 Averaging Data Slicer Mode

The averaging data slicer mode is the default setting for the data path of the MLX71122. Bit SLCSEL in register R0 (see 4.1.1) is LOW if it is active and switch SW2 connects the pin SLC with DFO via a $200k\Omega$ resistor (see Fig. 1). With an external capacitor C10 at pin SLC, a simple low pass filter is formed that generates the threshold voltage for the output comparator. The value of C10 depends on the length of the packet preamble, the coding and the data rate. The larger the C10 value the longer the time until valid output data can be received at pin DTAO.

We recommend using the averaging data slicer mode for bi-phase or Manchester encoded bit streams since the DC-content of these codes is almost zero. The RC-time constant of the slicer can be calculated using:

$$t_{SLC} = 200k\Omega \cdot C10 \tag{15}$$

We recommend that t_{SLC} is at least 25 times as long as the bit time of the equivalent NRZ signal.

Example: base band signal 4kbps, NRZ coding

$$C10 = \frac{25 \cdot 0.25ms}{200k\Omega} = 31.25nF \quad \text{ in E-series} \implies C10 = 33nF$$



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3.5.3 Peak Detectors (PKDET)

Peak detector mode is recommended for fast acquisition of the received data and if NRZ code is used. The peak detectors can be activated by setting SLCSEL to HIGH in register R0 (see 4.1.1). This connects SLC (pin 32) with the resistive voltage divider between PDP (pin 25) and PDN (pin 26) (see Fig. 1). The peak detector at PDP is used to detect the maximum of the voltage at DFO and the peak detector at PDN detects the minimum of the voltage at DFO. Since the voltage divider is symmetric, the threshold voltage will be in the middle of the minimum and maximum voltages at DFO. The peak voltages are proportional to the charge that is stored on the peak detector capacitors at PDP (C11) and PDN (C12). All pull-up and pull-down currents are given in sec. 5.5. Because both pins are connected via a $2M\Omega$ resistor, both peak detector capacitors will be discharged with a time constant depending on the value of the capacitors. For equal values of both capacitors (C = C11 = C12), the time constant will be:

$$t_{DIS} = 2M\Omega \cdot 0.5 \cdot C \tag{16}$$

The minimum value of t_{DIS} is limited by the maximum number of equally consecutive bits. A value of t_{DIS} of at least 128 times the bit time is a good choice since this is a common data package length.

Example: base band signal 4kbps, NRZ coding

$$C11 = C12 = \frac{128 \cdot 0.25 \text{ms}}{0.5 \cdot 2\text{M}\Omega} = 32\text{nF} \qquad \text{in E-series} \implies C11 = C12 = 33\text{nF}$$

The maximum capacitor value may also be limited by the pull-up and pull-down currents of the peak detectors given in sec. 5.5, because C11 and C12 have to be charged during the first bits of the preamble of the data packet.

3.5.4 Output Comparator

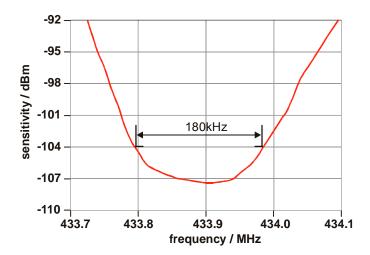
The output comparator or data slicer decides whether the incoming signal is a digital LOW or HIGH by using the reference voltage at SLC (pin 32). If the internal voltage is larger than the reference then the output is HIGH and vice versa. Nevertheless, the polarity of the output comparator can be inverted. The driving capability of the comparator output is ± 2 mA and in standby mode the tri-state output is at high impedance. Pin DTAO must not be connected by a low impedance to a fixed voltage supply or a stronger driver output! We recommend using a series resistance of 10k Ω to connect DTAO.

3.6 Frequency Acceptance Range

The frequency acceptance range is defined as the bandwidth where the input sensitivity can be degraded by 3dB at a maximum, compared to the sensitivity at the center frequency of the channel.

Typically, the frequency acceptance range of the MLX71122 is about 180kHz, see Fig.13. The frequency acceptance range is mainly depending on the frequency deviation, and slightly on the modulation frequency. The larger the frequency deviation the smaller the acceptance range.

Fig. 13: Measured sensitivity characteristic (BER= $3\cdot10^{-3}$, 4kbps, $\Delta f=\pm20$ kHz)





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3.7 Biasing System

The biasing system needs an external $30k\Omega$ resistor that is connected between RBIAS (pin 10) and the PCB ground. The band-gap voltage at RBIAS causes a reference current flow of about 42 μ A through this reference current resistor. The accuracy of the external resistor should be within $\pm 2\%$. To minimize the temperature dependency it is recommended to use a metal film resistor.

3.8 Operating Modes

The MLX71122 has four operating modes having an impact on the receiver's current consumption. The OPMODE bits in register R0 (see 4.1.1) determine the operating mode. Selections are:

00 – Shutdown all blocks deactivated, only SPI active (default)
 01 – Receive receiving data from LNAI at selected frequency

10 – RO and bias only only biasing system and reference oscillator are working

• 11 – Synthesizer only only biasing system, reference oscillator and PLL are working

The first operating mode consumes virtually no current. The circuit is dead except of the SPI that can listen to commands. In Receive mode all necessary blocks are turned on in order to receive data at the programmed frequency.

The last two operating modes can be used to accelerate the start-up time of the circuit after periods of silence. With RO and bias only, the start-up time of the reference oscillator (RO) can be circumvented. RO and biasing consume not as much current as the whole receiver. With Synthesizer only the full PLL is already working and locked. Current consuming blocks as the LNA, the IF-filter and the FSK-demodulator are turned off in this state. The last mode is useful if the receiver has to listen frequently.

3.9 Multi Functional Output

The Multi Functional Output (pin 23) can be used to read out the control register settings or to make other internal signals available at this pin. The output is controlled by the bits MFO in register R3 (see 4.1.4). The most important selections are:

• 0000 – Z-State MFO pin is in high impedance mode

• 0001 – SPI-out MFO pin is digital serial output for data of registers

0010 – Logic-0
 0011 – Logic-1
 MFO pin is pulled to ground
 MFO pin is pulled to VCC

0100 – RO-out
 MFO pin is buffered, analogue output of RO frequency (default)
 0101 – IF-out
 MFO pin is buffered, analogue output of IF2 signal after the IF-filter

1000 – LD-out MFO pin represents lock state of PLL

Z-State, Logic-0 and Logic-1 can be used to provide digital control signals to other circuits on the PCB. In state RO-out a 10MHz clock frequency is available at MFO, e.g. for driving a microcontroller. At IF-out pin MFO provides the IFF output, amplified by a factor of 5 (unloaded). In this case the output resistance is about 610Ω . The IF-out mode can be used for checking the IFF characteristics or for further signal processing, e.g. to add an external limiting amplifier and demodulator. With the LD-out setting the state of the PLL can be read out. All other selections are for test purposes

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3.10 SPI Description

3.10.1 General

Serial programming interface (SPI) mode can be activated by choosing SPISEL = 1 (e.g. at positive supply voltage V_{CC}). In this mode, the input pins 17, 18 and 19 are used as a 3-wire unidirectional serial bus interface (SDEN, SDTA, SCLK). The internal latches contain all user programmable variables including counter settings, mode bits etc.

In addition the MFO pin can be programmed as an output (see section 4.1.4) in order to read data from the internal latches and it can be used as an output for different test modes as well.

At each rising edge of the SCLK signal, the logic value at the SDTA terminal is written into a shift register. The programming information is taken over into internal latches with the rising edge of SDEN. Additional leading bits are ignored, only the last bits are serially clocked into the shift register. A normal write operation shifts 16 bits into the SPI, a normal read operation shifts 4 bits into the SPI and reads additional 12 bits from the MFO pin. If less than 12 data bits are shifted into SDTA during the write operation then the control register may contain invalid information.

In general a control word has the following format. Bit 0 is the Read/Write bit that determines whether it is a read (R/W = 1) or a write (R/W = 0) sequence. The R/W bit is preceding the latch address and the corresponding data bits.

| Control Word Format | | | | | | | | | | | | | | | |
|---------------------|-----|----|----|----|----|-----|----|----|----|----|-----|------|-------|------|-------|
| MSB | | | | | | | | | | | LSB | MSB | | LSB | Bit 0 |
| | | | | | Da | ıta | | | | | | Latc | h Add | ress | Mode |
| D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | A2 | A2 | A0 | R/W |

There are two control word formats for read and for write operation. Data bits are only needed in write mode. Read operations require only a latch address and a R/W bit.

Due to the static CMOS design, the serial interface consumes virtually no current. The SPI is a fully separate building block and can therefore be programmed in every operational mode.



3.10.2 Read / Write Sequences

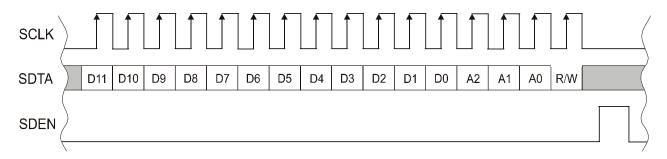


Fig. 14 Typical write sequence diagram

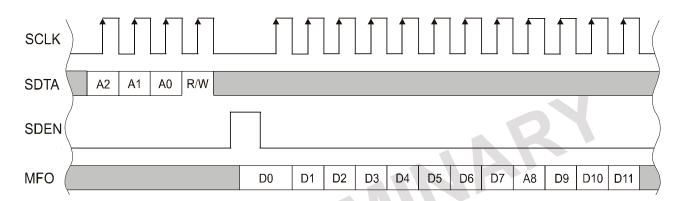


Fig. 15 Typical read sequence diagram

3.10.3 Serial Programming Interface Timing

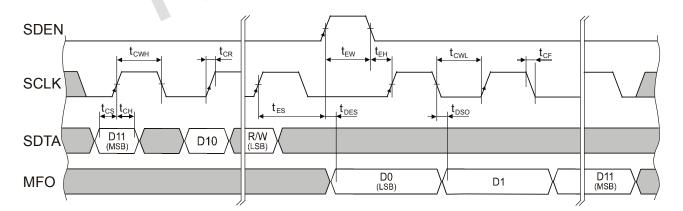


Fig. 16 SPI timing diagram

MLX71122 300 to 930MHz FSK/FM/ASK Receiver

4 Register Description

The following tables are to describe the functionality of the registers.

Sec. 4.1 provides a register overview with all the control words R0 to R7. The subsequent sections. 4.1.1 to 4.1.8 show the content of the control words in more detail.

Programming the registers requires SPI mode (SPISEL = 1). Default settings are for ABC mode.

4.1 Register Overview

| CONTROL WORD | MSB | | | | | DA | TA | | | | | LSB | | ATC | |
|--------------|--------|---------|--------|------------|----------|--------|----------|----------|---------|------------|--------|-------|-----|----------------|-----|
| Bit No. | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | MSB | | LSB |
| default | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 |
| R0 | DTAPOL | SLCSEL | SSBSEL | DEMGAIN | IFFGAIN | [1:0] | MIX2GAIN | MIX1GAIN | LNAGAIN | [1:0] | OPMODE | [1:0] | | read/ write | |
| Bit No. | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | MSB | | LSB |
| default | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1 |
| R1 | SHOWLD | PRESCUR | VCOBUF | VCOCUR | VCORANGE | LDMODE | LDTIME | [1:0] | LDERR | PFDPOL | CPCUR | [1:0] | | read/ write | |
| Bit No. | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | MSB | | LSB |
| default | 1 | 1 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | 0 |
| R2 | | | | N [6:0] | | | | | | A [4:0] | | | | read/ write | |
| Bit No. | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | MSB | | LSB |
| default | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 |
| R3 | | MFO | [3:0] | | AGCDEL | [1:0] | AGCEN | LO2DIV | | z | [10:7] | | | read/ write | |

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| CONTROL | | | | | | DA | TA | | | | | | | ATC | |
|---------|---------|----------|----------|--------|---|----|----------------|---------|-------|---|---|-----|-----|----------------|-----------|
| WORD | MSB | | | | | | | | | | | LSB | AL | DRE | 33 |
| Bit No. | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | MSB | | LSB |
| default | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 0 | 0 |
| R4 | AGCMODE | | | | | | R [10:0] | | | | | | | read/ write | |
| Bit No. | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | MSB | | LSB |
| default | 0 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 0 | 1 |
| R5 | MODSEL | | | | | | RIFF [10:0] | | | | | | | read/ write | |
| Bit No. | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | MSB | | LSB |
| default | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 0 |
| R6 | ROCUR | [1:0] | IFFTUNE | IFFHLT | | | | IFFPRES | [7:0] | | | | | read/ write | |
| Bit No. | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | MSB | | LSB |
| default | | | | | | | | | | | | | 1 | 1 | 1 |
| R7 | RSSIH | LDRSSIL* | IFFSTATE | [1:0] | | | | IFFVAL | [7:0] | | | | | read- only | |

Note: * depends on bit 11 in R4, 0 = RSSIL, 1 = LD

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4.1.1 Control Word R0

| Name | Bits | | | Description | | | | | | | | |
|----------|-------|----------------------|---|---|----------|--|--|--|--|--|--|--|
| | | | | operation mode | | | | | | | | |
| OPMODE | [1:0] | 00 01 10 11 | shutdown receive mode reference oscillato synthesizer only | eceive mode eference oscillator & BIAS only | | | | | | | | |
| | | | | LNA gain | | | | | | | | |
| LNAGAIN | [3:2] | 00 01 10 11 | lowest gain low gain high gain highest gain | (default – 20dB) (default – 6dB) (default – 2dB) (default – 0dB) | #default | | | | | | | |
| | | | gain values are relative t | | | | | | | | | |
| MIX1GAIN | [4] | 0 1 | high gain low gain | 1 st Mixer gain (14dB) (0dB) | #default | | | | | | | |
| | | - | | 2 nd Mixer gain | | | | | | | | |
| MIX2GAIN | [5] | 0 1 | high gain low gain | (9dB) (-2dB) | #default | | | | | | | |
| | | | inte | rmediate frequency filter gain | | | | | | | | |
| IFFGAIN | [7:6] | 00 01 10 11 | lowest gain low gain high gain highest gain | (-14dB) (-6dB) (0dB) (+6dB) | #default | | | | | | | |
| | | | | demodulator gain | | | | | | | | |
| DEMGAIN | [8] | 0 1 | low gain high gain | (~ 4mV/kHz) (~ 15mV/kHz) | #default | | | | | | | |
| | | | | single side band selection | | | | | | | | |
| SSBSEL | [9] | 0 1 | upper side band lower side band | LO2 low-side inj. (IF1 = LO2 + IF2) LO2 high-side inj. (IF1 = LO2 - IF2) | #default | | | | | | | |
| | | | Internal IF2 = 2MHz | | | | | | | | | |
| | | | | slicer mode select | | | | | | | | |
| SLCSEL | [10] | 0 1 | averaging Data Sli peak detector Data | | #default | | | | | | | |
| | | | | data output polarity OA2 | | | | | | | | |
| | | 0 | inverted | | | | | | | | | |
| DTAPOL | [11] | | | | | | | | | | | |
| | | 1 | normal | | #default | | | | | | | |
| | | | '0' for space at ASK or fr | min at FSK, '1' for mark at ASK or f _{max} at FSK | | | | | | | | |

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4.1.2 Control Word R1

| Name | Bits | | Description | | |
|-------------|-------|-------------------------|--|----------|--|
| | | | charge pump current setting | | |
| CPCUR | [1:0] | 00 01 10 11 | 100μA 400μA 400μA static down 400μA static up | #default | |
| | | | PFD output polarity | | |
| PFDPOL | [2] | 0 1 | negative positive | #default | |
| | | | lock detector time error | | |
| LDERR | [3] | 0 1 | 15ns 30ns | #default | |
| | | | lock detection time | | |
| LDTIME | [5:4] | 00 01 10 11 | 2/f _R 4/f _R 8/f _R 16/f _R | #default | |
| | | | minimum time span before lock in f_R is the reference oscillator frequency f_{RO} divided by R, see section 4.1.5 (I | R4) | |
| | | | lock detector mode | | |
| LDMODE | [6] | 0 1 | check lock condition permanently check lock condition until 1 st lock in | #default | |
| | | | VCO range | | |
| VCORANGE | [7] | 0 1 | 3V supply 5V supply | #default | |
| | | | VCO range setting for different VCCs. | | |
| VCOCUR | [0] | | VCO core current | 44-1-614 | |
| VCOCOR | [8] | 0 1 | 450μA 520μA | #default | |
| | | | VCO buffer current | | |
| VCOBUF | [9] | 0 1 | 900μA 1040μA | #default | |
| | | | prescaler 32/33 reference current | | |
| PRESCUR | [10] | 0 1 | 20μA 30μA | #default | |
| | | | $30\mu\text{A}$ may be used for f_{RF} = $868/915\text{MHz}$ | | |
| | | function of LDRSSIL bit | | | |
| SHOWLD [11] | | 0 1 | RSSIL (RSSI low flag) LD (lock detection flag) | #default | |
| | | | | | |

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4.1.3 Control Word R2

| Name | Bits | | Description | | | |
|------|--------|---------------|------------------------------------|----------|--|--|
| | | | swallow counter value | | | |
| Α | [4:0] | 01100 | value is 12 | #default | | |
| | | | swallow counter range: 0 to 31 | | | |
| | | | program counter value (bits 0 – 6) | | | |
| N | [11:5] | 000 0111 0111 | N value is 119 | #default | | |
| | | | N counter range: 3 to 2047 | | | |

4.1.4 Control Word R3

| | | | program counter range (bits 7 – 10) | | |
|--------|----------------|--|--|--|----------|
| N | [3:0] | 000 01 | 000 0111 0111 N value is 119 | | |
| | | | | N counter range: 3 to 2047 | |
| | | | | LO2 divider ratio | 4 |
| LO2DIV | [4] | 0 1 | divide b | | #default |
| | | | | AGC enable mode | |
| AGCEN | [5] | 0 1 | disabled enabled | | #default |
| | [7:6] 0 | | AGC delay settings | | |
| AGCDEL | | 00 01 10 11 | no delay 3/f _{IFF} 15/f _{IFF} 31/f _{IFF} | / | #default |
| | | | f _{IFF} is the r | reference oscillator frequency f_{RO} divided by RIFF, see section 4. | 1.6 (R6) |
| | | | | multi functional output | |
| MFO | [11:8] | 0000 0001 0010 0011 0100 0101 1000 | MFO is 3 MFO = 0 MFO = 1 MFO is 3 | | #default |



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4.1.5 Control Word R4

| Name | Bits | Description | | | | |
|-----------------|------|--------------|--|----------|--|--|
| | | | reference divider range | | | |
| R [10:0] | | 000 0100 101 | value is 75 | #default | | |
| | | | R counter range: 3 to 2047 | | | |
| | | | AGC delay mode | | | |
| AGCMODE | [11] | | gain decrease and increase with delay gain decrease without delay, gain increase with delay | | | |
| | | selects A | GC delay mode in combination with AGCDEL bits, see section 4.1 | I.4 (R3) | | |

4.1.6 Control Word R5

| Name | Bits | | Description | | | |
|--------------------|------|---------------|--|--|----------|--|
| | | | reference divider value for IFF adjustment | | | |
| RIFF [10:0] | | 010 1010 1100 | | value is 684 | #default | |
| | | | | IFF counter range: 4 to 2047 | | |
| | | | | demodulation selection | | |
| MODSEL | [11] | 0 1 | 0 FSK demodulation 1 ASK demodulation | | #default | |
| | | | selects mo | dulation type when chip is controlled via SPI mode | | |

4.1.7 Control Word R6

| Name | Bits | | Description | | | | |
|----------------------|-------|----------------------|---------------------------------|---|----------|--|--|
| | | | | IFF preset value | | | |
| IFFPRES | [7:0] | 100 | 0 0101 | value is 133 | #default | | |
| | | | | IFF DAC preset at start of automatic tuning | | | |
| | | | IFF halt | | | | |
| IFFHLT | [8] | 0 1 | | ning running ning halted | #default | | |
| | | | suspends l | IFF automatic tuning | | | |
| | | | | IFF tuning | | | |
| IFFTUNE | [9] | 0 1 | disable enable | and load DAC with IFFPRES | #default | | |
| | | | | reference Oscillator core current | | | |
| ROCUR [11:10] | | 00 01 10 11 | 85μΑ 170μΑ 270μΑ 355μΑ | | #default | | |

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4.1.8 Control Word R7 (Read-only Register)

| Name | Bits | Description | | | | |
|----------|-------|---|--|--|--|--|
| | | IFF adjustment value | | | | |
| IFFVAL | [7:0] | | | | | |
| | | see also IFFPRES in section 4.1.7 (R6) | | | | |
| | | IFF automatic tuning state | | | | |
| IFFSTATE | [9:8] | filter tuned or auto-tuning disabled tuning up the filter frequency tuning down the filter frequency master oscillator of filter does not work | | | | |
| | | lock detector or RSSI low flag | | | | |
| LDRSSIL | [10] | PLL not locked or RSSI value in lower region PLL locked or RSSI value above lower region | | | | |
| | | pends on SHOWLD in section 4.1.2 (R1) | | | | |
| | | RSSI high flag | | | | |
| RSSIH | [11] | RSSI value below upper regionRSSI value in upper region | | | | |
| | P | | | | | |



5 Technical Data

5.1 Absolute Maximum Ratings

Operation beyond absolute maximum ratings may cause permanent damage of the device.

| Parameter | Symbol | Condition / Note | Min | Max | Unit |
|-------------------------|-------------------|----------------------|-------|----------------------|------|
| Supply voltage | V _{CC} | | 0 | 7.0 | V |
| Input voltage | V _{IN} | | - 0.3 | V _{cc} +0.3 | V |
| Input RF level | P _{iRF} | @ LNA input | | 10 | dBm |
| Storage temperature | T _{STG} | | -55 | +125 | °C |
| Junction temperature | TJ | | | +150 | °C |
| Thermal Resistance | R _{thJA} | | | 60 | K/W |
| Power dissipation | P _{diss} | | | 0.1 | W |
| Electrostatic discharge | V _{ESD1} | human body model, 1) | -1.0 | +1.0 | kV |
| Electiostatic discharge | V _{ESD2} | human body model, 2) | -0.75 | +0.75 | ٨V |

¹⁾ all pins except LNAO

5.2 Normal Operating Conditions

| Parameter | Symbol | Condition | Min | Max | Unit |
|-----------------------------|------------------|--|-----------------------|-----------------------|------|
| Supply voltage | V_{CC} | | 3.0 | 5.5 | V |
| Operating temperature | T _A | | -40 | +105 | °C |
| Input low voltage (CMOS) | V _{IL} | ENRX, SEL pins, A/SCLK B/SDTA, C/SDEN | | 0.3 · V _{CC} | V |
| Input high voltage (CMOS) | V _{IH} | ENRX, SEL pins, A/SCLK B/SDTA, C/SDEN | 0.7 · V _{CC} | | V |
| Input frequency range | f _{RF} | | 300 | 930 | MHz |
| IF1 range | f _{IF1} | | 80 | 190 | MHz |
| IF2 range | f _{IF2} | | | 2 | MHz |
| XOSC frequency | f_{ref} | set by the crystal | | 10 | MHz |
| VCO frequency | f_{LO} | | 400 | 750 | MHz |
| Frequency offset of carrier | f _{CAR} | | -100 | 100 | kHz |
| Frequency deviation | Δf | | ±10 | ±50 | kHz |
| FSK data rate | R _{FSK} | NRZ | | 100 | kbps |
| ASK data rate | R _{ASK} | NRZ | | 100 | kbps |
| FM bandwidth | f _m | | | 15 | kHz |

²⁾ pin LNAO

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5.3 Crystal Parameters

| Parameter | Symbol | Condition | Min | Max | Unit |
|--------------------|----------------|----------------------|-----|-----|------|
| Crystal frequency | f_0 | fundamental mode, AT | | 10 | MHz |
| Load capacitance | C_L | | 10 | 15 | pF |
| Static capacitance | C ₀ | | | 7 | pF |
| Series resistance | R ₁ | | | 70 | Ω |

5.4 Serial Programming Interface (SPI)

| Parameter | Symbol | Condition | Min | Max | Unit |
|-------------------------------|-------------------|------------|-----------------------|-----------------------|------|
| Input High Voltage | V _{IH} | | V _{CC} - 0.4 | | V |
| Input Low Voltage | V _{IL} | | | 0.4 | V |
| SLCK frequency | f _{SLCK} | | | 10 | MHz |
| SLCK period | t _{SLCK} | | 100 | | ns |
| SDTA to SCLK set up time | t _{CS} | | 20 | | ns |
| SCLK to SDTA hold time | t _{CH} | | 20 | | ns |
| SCLK pulse width low | t _{CWL} | | 50 | | ns |
| SCLK pulse width high | t _{CWH} | | 50 | | ns |
| SCLK to SDEN set up time | t _{ES} | | 30 | | ns |
| SDEN pulse width | t _{EW} | | 50 | | ns |
| SDEN to SCLK hold time | 1 | | 20 | | ns |
| Rising Edge of SLCK | t _{CR} | 4 11 11 11 | | 0.1 t _{SLCK} | ns |
| Falling Edge of SLCK | t _{CF} | | | 0.1 t _{SLCK} | ns |
| SDEN to MFO data set-up time | t _{DES} | | | 70 | ns |
| SCLK to MFO data set-up time | t _{DSO} | | | 50 | ns |
| MFO max. pin load capacitance | C _{LMFO} | | | 20 | pF |

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5.5 DC Characteristics

all parameters under normal operating conditions and default settings, unless otherwise stated; typical values at T_A = 23 °C and V_{CC} = 5 V

all parameters based on test circuits as shown in Fig. 17 to Fig. 19

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|-----------------------------------|----------------------|---|-----------------------|------|-----------------------|----------|
| Operating Currents | | | • | | | |
| Shutdown current | I _{SBY} | OPMODE=00 and ENRX=0 | | 50 | 500 | nA |
| Supply current, FSK | I _{FSK} | OPMODE=01 or ENRX=1 | 10 | 12 | 15 | mA |
| Supply current, ASK | I _{ASK} | OPMODE=01 or ENRX=1 | 9.5 | 11.5 | 14.5 | mA |
| Supply current, RO only | I _{RO} | OPMODE=10 and ENRX=0 | 0.4 | 8.0 | 1.2 | mA |
| Supply current, Synthesizer only | I _{SYN} | OPMODE=11 and ENRX=0 | 3 | 4 | 5 | mA |
| Digital Pin Characteristics | | | | | | |
| Input low voltage CMOS, ENRX | V_{ILEN} | ENRX pin | -0.3 | | 0.3 · V _{cc} | V |
| Input high voltage CMOS, ENRX | V _{IHEN} | ENRX pin | 0.7 · V _{CC} | | V _{CC} +0.3 | V |
| Pull down current ENRX pin | I _{PDEN} | ENRX=1 | 3.5 | 5 | 7 | μΑ |
| Low level input current ENRX pin | I _{INLEN} | ENRX=0 | | | 0.05 | μΑ |
| Input low voltage CMOS | V _{IL} | Pins MODSEL, SPISEL, A/SCLK, B/SDTA, C/SDEN | -0.3 | | 0.3 · V _{cc} | V |
| Input high voltage CMOS | V _{IH} | Pins MODSEL, SPISEL, A/SCLK, B/SDTA, C/SDEN | 0.7 · V _{CC} | | V _{CC} +0.3 | V |
| Low level input leakage current | I _{IL} | Pins MODSEL, SPISEL, A/SCLK, B/SDTA, C/SDEN | -2 | | | μА |
| High level input leakage current | I _{HL} | Pins MODSEL, SPISEL, A/SCLK, B/SDTA, C/SDEN | | | 2 | μА |
| Analog Pin Characteristics | | | | | | |
| OA1 input offset voltage | V_{OFFOA1} | OA1 | -50 | | 50 | mV |
| OA2 input offset voltage | V _{OFFOA2} | OA2 | -50 | | 50 | mV |
| OA2 current sinking capability | I _{OA2SINK} | OA2 (DTAO pin) | | | 2 | mA |
| OA2 current sourcing capability | I _{OA2SRC} | OA2 (DTAO pin) | | | 2 | mA |
| Peak detector P pull-up current | I _{PDPPU} | PDP | | 235 | | μΑ |
| Peak detector N pull-down current | I _{PDNPD} | PDN | | 270 | | μА |

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5.6 AC System Characteristics

all parameters under normal operating conditions and default settings, unless otherwise stated; typical values at T_A = 23 °C and V_{CC} = 5 V, RF at 433.92 MHz all parameters based on test circuits as shown in Fig. 17 to Fig. 19

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|---|-----------------------------|---|------|------|-------------------------------|-------|
| Receive Characteristics | | | | | | |
| Input sensitivity – FSK (standard) | P _{min, FSK} | $\Delta f = \pm 20 \text{kHz},$ 4kbps NRZ, BER $\leq 3.10^{-3}$ | | -107 | | dBm |
| Input sensitivity – FSK (with carrier offset) | P _{min, FSK,} offs | $\Delta f = \pm 20 \text{kHz},$ 4kbps NRZ, $\pm 90 \text{kHz}$ carrier offset BER $\leq 3.10^{-3}$ | | -104 | | dBm |
| Input sensitivity – ASK | P _{min, ASK} | 100% on-off ratio 4kbps NRZ, BER $\leq 3.10^{-3}$ | | -112 | | dBm |
| Maximum input signal – FSK/FM | P _{max, FSK} | BER ≤ 3·10 ⁻³ | | 0 | | dBm |
| Maximum input signal – ASK | P _{max, ASK} | BER ≤ 3·10 ⁻³ | | -10 | | dBm |
| Spurious emission | P _{spur} | | | | -54 | dBm |
| Image rejection of MIX2 | ΔP_{imag} | | 4 | 35 | | dB |
| IF Filter Parameters | | | | | | |
| Center frequency | f _{IF} | | | 2 | | MHz |
| 3dB bandwidth | B _{3dB} | | | 230 | | kHz |
| 40dB bandwidth | B _{40dB} | | | 1.6 | | MHz |
| RSSI Characteristics | | | | | | |
| Low voltage | V _{LRSSI} | | | | 1 | V |
| High voltage | V _{HRSSI} | | 2.65 | | | V |
| RSSI dynamic range | DR _{RSSI} | | | 50 | | dB |
| RSSI slope | S _{RSSI} | maximum | | 40 | | mV/dB |
| FSK Demodulator | | | | | | |
| Demodulator gain, low | DG _{LOW} | $\Delta f > \pm 15 kHz$ | | 4 | | mV/ |
| Demodulator gain, high | DG _{HIGH} | ∆f < ±15kHz | | 15 | | kHz |
| Maximum data rate | B_DEM | NRZ | | | 100 | kbps |
| Frequency acceptance range | BW_{DEMOD} | $\Delta f = \pm 20kHz$ | 230 | | | kHz |
| Start-up Parameters | | | | | | |
| Crystal start-up time | T _{XTL} | ENRX from 0 to 1 | | 0.9 | | ms |
| Receiver start-up time | T _{RX} | ENRX from 0 to 1, depends on data slicer time constant, valid data at output | | | T _{XTL} + 200k · C10 | |
| PLL Parameters | | | | | | |
| VCO gain @ 433MHz | K _{VCO} | max for VCORANGE=0 | | 83 | 100 | MHz/V |
| VCO gain @ 868MHz | K _{VCO} | max for VCORANGE=0 | | 105 | 126 | MHz/V |
| Charge pump current | I _{CP} | depends on CPCUR | 100 | | 400 | μΑ |



6 Test Circuits

6.1 Standard FSK & ASK Reception in 8-Channel Preconfigured (ABC) Mode

6.1.1 Averaging Data Slicer Configured for Bi-Phase Codes

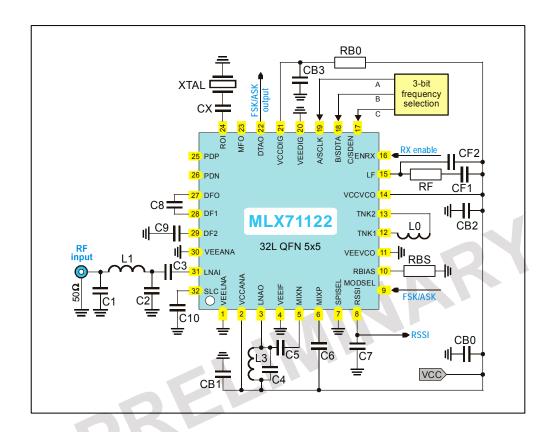


Fig. 17: Test circuit for FSK & ASK reception



6.2 Standard FSK & ASK Reception in SPI Mode

6.2.1 Averaging Data Slicer Configured for Bi-Phase Codes

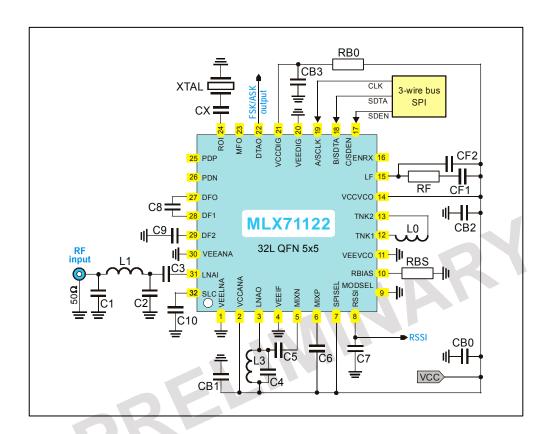


Fig. 18: Test circuit for FSK & ASK reception



6.2.2 Peak Detector Data Slicer Configured for NRZ Codes

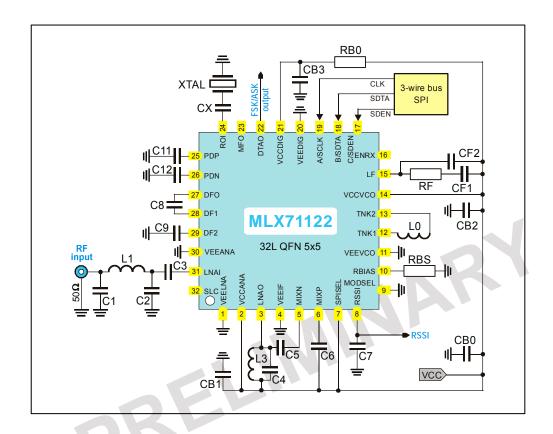


Fig. 19: Test circuit for FSK & ASK reception

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6.3 Test Circuit Component List

Below table is for all test circuits shown in Figures 17 to 19.

| Part | Size | Value @ 315 MHz | Value @ 433.92 MHz | Value @ 868.3 MHz | Value @ 915 MHz | Tol. | Description | |
|------|--------------|--|-----------------------------|-------------------------|--------------------|------|---|--|
| C1 | 0603 | 3.9 pF | 4.7 pF | 3.3 pF | 1.5 pF | ±5% | matching capacitor | |
| C2 | 0603 | 1.5 pF | 1.5 pF | 1.5 pF | 1.5 pF | ±5% | matching capacitor | |
| C3 | 0603 | 100 pF | 100 pF | 100 pF | 100 pF | ±5% | LNA input filtering capacitor | |
| C4 | 0603 | 4.7 pF | 3.3 pF | 2.7 pF | 2.2 pF | ±5% | LNA output tank capacitor | |
| C5 | 0603 | 100 pF | 100 pF | 100 pF | 100 pF | ±5% | MIX1 negative input matching capacitor | |
| C6 | 0603 | 100 pF | 100 pF | 100 pF | 100 pF | ±5% | MIX1 negative input matching capacitor | |
| C7 | 0603 | 1 nF | 1 nF | 1 nF | 1 nF | ±10% | RSSI output low pass capacitor, for data rate of 4 kbps NRZ | |
| C8 | 0603 | 330 pF | 330 pF | 330 pF | 330 pF | ±10% | data low-pass filter capacitor, for data rate of 4 kbps NRZ | |
| C9 | 0603 | 150 pF | 150 pF | 150 pF | 150 pF | ±10% | data low-pass filter capacitor, for data rate of 4 kbps NRZ | |
| C10 | 0603 | 33 nF | 33 nF not required i | 33 nF n Figure 19 | 33 nF | ±10% | data slicer capacitor, for data rate of 4 kbps NRZ | |
| C11 | 0603 | 33 nF | 33 nF | 33 nF | 33 nF | ±10% | PKDET positive filtering capacitor, for data rate of 4 kbps NRZ | |
| | | 33 nF | ot required in Fig | | | | | |
| C12 | 0603 | | 33 nF ot required in Fig | 33 nF cures 17 and 1 | 33 nF 8 | ±10% | PKDET negative filtering capacitor, for data rate of 4 kbps NRZ | |
| CB0 | 1210 | 10 μF | 10 μF | 10 μF | | | decoupling capacitor, low-noise power supply recommended | |
| CB1 | 0603 | 470 pF | 470 pF | 470 pF | 470 pF | ±10% | decoupling capacitor | |
| CB2 | 0603 | 33 nF | 33 nF | 33 nF | 33 nF | ±10% | decoupling capacitor | |
| CB3 | 0603 | 33 nF | 33 nF | 33 nF | 33 nF | ±10% | decoupling capacitor | |
| CF1 | 0603 | 2.2 nF | 2.2 nF | 2.2 nF | 2.2 nF | ±5% | loop filter capacitor | |
| CF2 | 0603 | 220 pF | 220 pF | 220 pF | 220 pF | ±5% | loop filter capacitor | |
| CX | 0603 | 27 pF | 27 pF | 27 pF | 27 pF | ±5% | crystal series capacitor | |
| RB0 | 0603 | 10 Ω | 10 Ω | 10 Ω | 10 Ω | ±5% | protection resistor | |
| RF | 0603 | 27 kΩ | 27 kΩ | 47 kΩ | 47 kΩ | ±5% | loop filter resistor | |
| RBS | 0603 | 30 kΩ | 30 kΩ | 30 kΩ | 30 kΩ | ±2% | reference bias resistor | |
| L0 | 0603 | 33 nH | 15 nH | 8.2 nH | 8.2 nH | ±5% | VCO tank inductor | |
| L1 | 0603 | 68 nH | 47 nH | 22 nH | 15 nH | ±5% | matching inductor | |
| L3 | 0603 | 33 nH | 22 nH | 5.6 nH | 5.6 nH | ±5% | LNA output tank inductor | |
| XTAL | SMD 5x3.2 | 10.00000 MHz \pm 20ppm cal., \pm 30ppm temp. | | | | | fundamental-mode crystal | |



7 Package Description



The device MLX71122 is RoHS compliant.

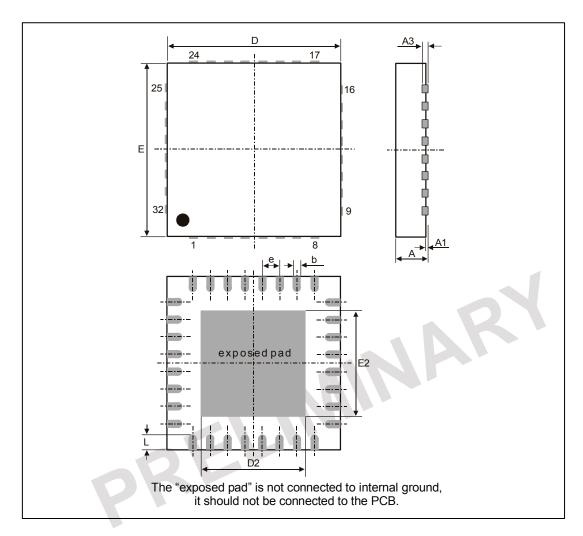


Fig. 20: 32L QFN 5x5 Quad

| all Dimension in mm | | | | | | | | | | |
|-----------------------|-------|-------|-------|-------|--------|-------|--------|--------|--------|--------|
| | D | Е | D2 | E2 | Α | A1 | А3 | L | е | b |
| min | 4.75 | 4.75 | 3.00 | 3.00 | 0.80 | 0 | 0.20 | 0.3 | 0.50 | 0.18 |
| max | 5.25 | 5.25 | 3.25 | 3.25 | 1.00 | 0.05 | | 0.5 | | 0.30 |
| all Dimension in inch | | | | | | | | | | |
| min | 0.187 | 0.187 | 0.118 | 0.118 | 0.0315 | 0 | 0.0079 | 0.0118 | 0.0197 | 0.0071 |
| max | 0.207 | 0.207 | 0.128 | 0.128 | 0.0393 | 0.002 | 0.0079 | 0.0197 | | 0.0118 |

7.1 Soldering Information

 The device MLX71122 is qualified for MSL3 with soldering peak temperature 260 deg C according to JEDEC J-STD-20

MLX71122 300 to 930MHz FSK/FM/ASK Receiver

8 Reliability Information

This Melexis device is classified and qualified regarding soldering technology, solderability and moisture sensitivity level, as defined in this specification, according to following test methods:

Reflow Soldering SMD's (Surface Mount Devices)

- IPC/JEDEC J-STD-020
 - "Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices (classification reflow profiles according to table 5-2)"
- EIA/JEDEC JESD22-A113
 - "Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing (reflow profiles according to table 2)"

Wave Soldering SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

- EN60749-20
 - "Resistance of plastic- encapsulated SMD's to combined effect of moisture and soldering heat"
- EIA/JEDEC JESD22-B106 and EN60749-15
 - "Resistance to soldering temperature for through-hole mounted devices"

Iron Soldering THD's (Through Hole Devices)

EN60749-15

"Resistance to soldering temperature for through-hole mounted devices"

Solderability SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

 EIA/JEDEC JESD22-B102 and EN60749-21 "Solderability"

For all soldering technologies deviating from above mentioned standard conditions (regarding peak temperature, temperature gradient, temperature profile etc) additional classification and qualification tests have to be agreed upon with Melexis.

The application of Wave Soldering for SMD's is allowed only after consulting Melexis regarding assurance of adhesive strength between device and board.

Melexis is contributing to global environmental conservation by promoting **lead free** solutions. For more information on qualification of **RoHS** compliant products (RoHS = European directive on the Restriction Of the Use of Certain Hazardous Substances) please visit the quality page on our website:

http://www.melexis.com/quality_leadfree.aspx

9 ESD Precautions

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD). Always observe Electro Static Discharge control procedures whenever handling semiconductor products.



MLX71122 300 to 930MHz

FSK/FM/ASK Receiver

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